### 2.5V Drive Pch MOS FET

## RTR025P02

## -Features

1) Low On-resistance.
2) Built-in G-S Protection Diode.
3) Small and Surface Mount Package (TSMT3).

## -Application

Power switching, DC / DC converter.

## -Structure

Silicon P-channel
MOS FET
-External dimensions (Unit : mm)

## TSMT3


(1) Gate
(2) Source
(3) Drain

Each lead has same dimensions
Abbreviated symbol : TY
-Packaging specifications

| Type | Package | Taping |
| :--- | :--- | :---: |
|  | Code | TL |
|  | Basic ordering unit (pieces) | 3000 |
| RTR025P02 |  | $\bigcirc$ |

- Absolute maximum ratings ( $\mathrm{Ta}=25^{\circ} \mathrm{C}$ )

| Parameter |  | Symbol | Limits | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Drain-source voltage |  | Voss | -20 | V |
| Gate-source voltage |  | Vass | $\pm 12$ | V |
| Drain current | Continuous | ID | $\pm 2.5$ | A |
|  | Pulsed | Idp *1 | $\pm 10$ | A |
| Source current (Body diode) | Continuous | Is | -0.8 | A |
|  | Pulsed | Isp *1 | -3.2 | A |
| Total power dissipation |  | PD ${ }^{* 2}$ | 1.0 | W |
| Channel temperature |  | Tch | 150 | ${ }^{\circ} \mathrm{C}$ |
| Range of Storage temperature |  | Tstg | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Pw $\mathrm{P} \leq 10 \mu \mathrm{~s}$, Duty cycle $\leq 1 \%$
*2 Mounted on a ceramic board
-Thermal resistance

| Parameter | Symbol | Limits | Unit |
| :---: | :---: | :---: | :---: |
| Channel to ambient | Rth (ch-a)* | 125 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

*Mounted on a ceramic board.
$\bullet$ Equivalent circuit


Transistors

## - Electrical characteristics ( $\mathrm{Ta}=25^{\circ} \mathrm{C}$ )

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Gate-source leakage | lass | - | - | $\pm 10$ | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{GS}}= \pm 12 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| Drain-source breakdown voltage | $\mathrm{V}_{\text {(BR) } \mathrm{DSS}}$ | -20 | - | - | V | $\mathrm{ld}=-1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{Gs}}=0 \mathrm{~V}$ |
| Zero gate voltage drain current | loss | - | - | -1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DS}}=-20 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |
| Gate threshold voltage | $V_{G S}($ th) | -0.7 | - | -2.0 | V | $\mathrm{V}_{\mathrm{DS}}=-10 \mathrm{~V}, \mathrm{ld}=-1 \mathrm{~mA}$ |
| Static drain-source on-state resistance | $\operatorname{Ros}(0 n)^{*}$ | - | 70 | 95 | $\mathrm{m} \Omega$ | $\mathrm{ld}=-2.5 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=-4.5 \mathrm{~V}$ |
|  |  | - | 75 | 105 | $\mathrm{m} \Omega$ | $\mathrm{ld}=-2.5 \mathrm{~A}, \mathrm{VGS}=-4.0 \mathrm{~V}$ |
|  |  | - | 115 | 160 | $\mathrm{m} \Omega$ | $\mathrm{ID}=-1.25 \mathrm{~A}, \mathrm{VGS}=-2.5 \mathrm{~V}$ |
| Forward transfer admittance | $\mid Y_{\text {fs }}$ \| * | 2.3 | - | - | S | V DS $=-10 \mathrm{~V}, \mathrm{ld}=-1.2 \mathrm{~A}$ |
| Input capacitance | Ciss | - | 630 | - | pF | $\begin{aligned} & V_{D S}=-10 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V} \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |
| Output capacitance | Coss | - | 110 | - | pF |  |
| Reverse transfer capacitance | Crss | - | 75 | - | pF |  |
| Turn-on delay time | $\mathrm{td}_{\text {d (on) }}$ * | - | 12 | - | ns | $\begin{aligned} & \mathrm{ID}=-1.25 \mathrm{~A} \\ & \mathrm{VDD}=-15 \mathrm{~V} \\ & \mathrm{VGS}=-4.5 \mathrm{~V} \\ & \mathrm{RL}=12 \Omega \\ & \mathrm{RG}=1 \Omega \\ & \hline \end{aligned}$ |
| Rise time | tr * | - | 18 | - | ns |  |
| Turn-off delay time | $\mathrm{td}_{\text {( off) }}$ | - | 50 | - | ns |  |
| Fall time | $\mathrm{tf}^{\text {f }}$ | - | 20 | - | ns |  |
| Total gate charge | $\mathrm{Q}_{9}$ | - | 7 | - | nC | $\begin{aligned} & \hline \mathrm{VD} \fallingdotseq-15 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{GS}}=-4.5 \mathrm{~V} \\ & \mathrm{ID}=-2.5 \mathrm{~A} \\ & \hline \end{aligned}$ |
| Gate-source charge | Qgs | - | 1.5 | - | nC |  |
| Gate-drain charge | $\mathrm{Q}_{\mathrm{gd}}$ | - | 2.0 | - | nC |  |

*Pulsed
-Body diode characteristics(Source-drain) ( $\mathrm{Ta}=25^{\circ} \mathrm{C}$ )

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Forward voltage | $\mathrm{V}_{\mathrm{SD}}$ | - | - | -1.2 | V | $\mathrm{I}_{\mathrm{s}}=-0.8 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |

## - Electrical characteristic curves



Fig. 1 Typical Transfer Characteristics


Fig. 4 Static Drain-Source On-State Resistance vs. Drain Current


Fig. 7 Typical Capacitance vs. Drain-Source Voltage


Fig. 2 Static Drain-Source On-State Resistance vs. Drain Current


Fig. 5 Static Drain-Source On-State Resistance vs. Drain Current


Fig. 8 Switching Characteristics


Fig. 3 Static Drain-Source On-State Resistance vs. Drain Current


Fig. 6 Reverse Drain Current vs.Source-Drain Voltage


Fig. 9 Dynamic Input Characteristics

## - Measurement circuits



Fig. 10 Switching Time Test Circuit


Fig. 12 Gate Charge Test Circuit


Fig. 11 Switching Time Waveforms

Fig. 13 Gate Charge Waveform

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